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Environmental Product Declaration

Product	Type of equipment /	UH50-A05C-XX06-F 0	B-0000-M2A	Heat meter				
	Product No.	UH50-C05C-XX06-F 0	B-0000-M2A	Heat meter				
		UH50-A21C-XX06-F 0	B-0000-M2A	Heat meter Heat meter				
		UH50-C21C-XX06-F 0	B-0000-M2A					
		UH50-A36C-XX06-F 0	B-0000-M2A	Heat meter				
		UH50-C36C-XX06-F 0B-0000-M2A UH50-A45C-XX06-F 0D-0000-M2A		Heat meter				
				Heat meter				
		UH50-C45C-XX06-F 0	D-0000-M2A	Heat meter Heat meter Heat meter Heat meter				
		UH50-A50C-XX06-F 0	D-0000-M2A					
		UH50-C50C-XX06-F 0	D-0000-M2A					
		UH50-A61C-XX06-E 0	N-0000-M2A					
		UH50-C61C-XX06-E 0	N-0000-M2A	Heat meter				
	Product line	UH50						
Process control	Siemens Switzerland L Building Technologies Gubelstrasse 22 CH-6301 Zug							
	Management System		since	by				
	ISO 9001 (Quality)		22.07.1986	SQS				
	ISO 14001 (Environm	ent)	20.10.1998	SQS				
	OHSAS 18001 (OH&S	•	01.01.2011	SQS				
Product use	Typical energy consum	ption	1kWh/a	1kWh/a				
			Mbus module 4. 410µW	2V / 1.5mA -> 63mW / Meter 1Ah@	93,6V/Year ->			
	Maintenance		Not necessary					
Risk of fire	Fire protection according	ng to	EN 60730					
	Fire load		variant *) see below					
Packaging	20-PAP Corrugated fib	er board	Packaging variant					
	22-PAP paper		Operating instruction SBT 18 languages 94g One-way, recyclable					
	Notes on disposal							
Materials	Total weight of device			var	riant *) see below			

Aramid fiber + NBR; halogen-free

The total weight of a device may deviate from the total of the weights of all individual components due to rounding.

variant

Sealing disk

Plastics

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Metals

Others

EPD - Type II According to ISO 14021

2g

40g

EPDM; halogen-free	Molded part / Seal	variant			
FKM; halogenated	Damping element	variant			
PBT; GF 15%; halogen-free	Cover + adapter plate	variant			
PBT; GF 20%; halogen-free	Cover small	variant			
PC; GF 10%; halogen-free	Housing bottom	62g			
PC; halogen-free	FBG housing + cover	128g			
PE; halogen-free	Shield	5g			
Al alloy; lacquered	Dial	7g			
Cu alloy	Receiving part	variant			
CuSn	Baffle plate	variant			
CuZnPb	Reflector plate	variant			
CuZn	Baffle plate	variant			
Steel; galvanized	Magnet plate	11g			
Steel; galvanized	Screws, plates	variant			
steel CrNi	Screws, plates	variant			
Cu / LSR / ETFE	Cable / Wire	60g			
Cu / LSR / ETFE / Steel alloy	Temperature sensor	variant			

PCBAs (Printed Circuit Board assembled)

Special components

(part of the assembled PCB)

Passive components Active components

FR4; halogenated; solder SnAgCu

157

157

157

157

157

1'050

1'050

1'050

1'050

1'050

1'050

Piezoceramic (PZT)

lcs

157pcs 8pcs 6pcs

Ultrasonic transducer

Main circuit board

Weights in brackets are already included in components declared under materials. (part of the assembled PCB)

	[g]	UH50-A05C-XX06- F 0B-0000-M2A	UH50-C05C-XX06- F 0B-0000-M2A	UH50-A21C-XX06- F 0B-0000-M2A	UH50-C21C-XX06- F 0B-0000-M2A	UH50-A36C-XX06- F 0B-0000-M2A	UH50-C36C-XX06- F 0B-0000-M2A	UH50-A45C-XX06- F 0D-0000-M2A	UH50-C45C-XX06- F 0D-0000-M2A	UH50-A50C-XX06- F 0D-0000-M2A	UH50-C50C-XX06- F 0D-0000-M2A	UH50-A61C-XX06- E 0N-0000-M2A	UH50-C61C-XX06- E 0N-0000-M2A
Total weight of device	L	952	954	908	910	1'023	1'025	3'158	3'158	3'158	3'158	6'688	6'688
Sealing disk		1	1	1	1	2	2	3	3	3	3	34	34
Molded part / Seal		7	9	7	9	7	9	15	15	15	15	15	15
Damping element		2	2	2	2	2	2	4	4	4	4	4	4
Cover + adapter plate		8	8	8	8	8	8	111	111	111	111	111	111
Cover small		18	18	18	18	18	18						
Receiving part		32	32	32	32	32	32	57	57	57	57	57	57
Baffle plate		1	1	3	3	4	4	2	2	2	2	2	2
Reflector plate	Ī	373	373	327	327	441	441	2'333	2'333	2'333	2'333	5'660	5'660
Baffle plate		3	3	3	3	3	3	14	14	14	14	26	26
Screws, plates		12	12	12	12	12	12	16	16	16	16	16	16
Screws, plates	Ī	20	20	20	20	20	20	109	109	109	109	109	109
Temperature sensor	Į	160	160	160	160	160	160	180	180	180	180	340	340
Fire load [M	1J]	12	12	12	12	12	12	15	15	15	15	19	19
Packaging													

Packaging



EPD - Type II According to ISO 14021

Disposal



The device is classified as waste electronic equipment in terms of the European Directive 2012/19/EU (WEEE) and must not be disposed of as unsorted municipal waste. The relevant national legal rules are to be adhered too. Regarding disposal, use the systems setup for collecting electronic waste.

Observe all local and applicable laws.

Comments

EU-directive 2011/65/EU (RoHS)

The device does not contain substances in concentrations and applications banned under the EU RoHS Directive.

Regulation (EC) No. 1907/2006 (REACH)

To the best of our knowledge and according to the information of our suppliers the above mentioned device and its packaging contain no substances of the candidate list according to Article 59 (1, 10) of the regulation (EC) No. 1907/2006 concerning the Registration, Evaluation, Authorisation and Restriction of Chemicals (REACH) in concentrations above 0.1 % w/w.

(Status according to the creation date of this document.)

The device is halogen-free with exception of:

Cable parts (ETFE Insulation); Damping body of ultrasonic transducer (FKM); Circuit board (TBBA)

Legal Disclaimer: This declaration is for information purpose only.

This Environmental Product Declaration does not constitute a guarantee of the composition of a product, neither does it guarantee that the product will retain a particular composition for a particular period.

Siemens Switzerland Ltd therefore does not assume liability for any error or for any consequences which may arise from the use of this information to the maximum extent under the law.

Please contact your local Siemens branch office to get further information on environmental aspects and disposal.

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